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3.3V CMOS 16-BIT BUS TRANSCIEVER WITH 3-STATE OUTPUTS AND BUS-HOLD

IDT74ALVCHR162245

FEATURES:

- 0.5 MICRON CMOS Technology
- Typical $t_{SK(o)}$ (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- V_{CC} = 3.3V ± 0.3V, Normal Range
- V_{CC} = 2.7V to 3.6V, Extended Range
- V_{CC} = 2.5V ± 0.2V
- CMOS power levels (0.4μ W typ. static)
- Rail-to-Rail output swing for increased noise margin
- Available in TSSOP package

DRIVE FEATURES:

- Balanced Output Drivers: ±12mA
- Low Switching Noise

APPLICATIONS:

- 3.3V high speed systems
- 3.3V and lower voltage computing systems
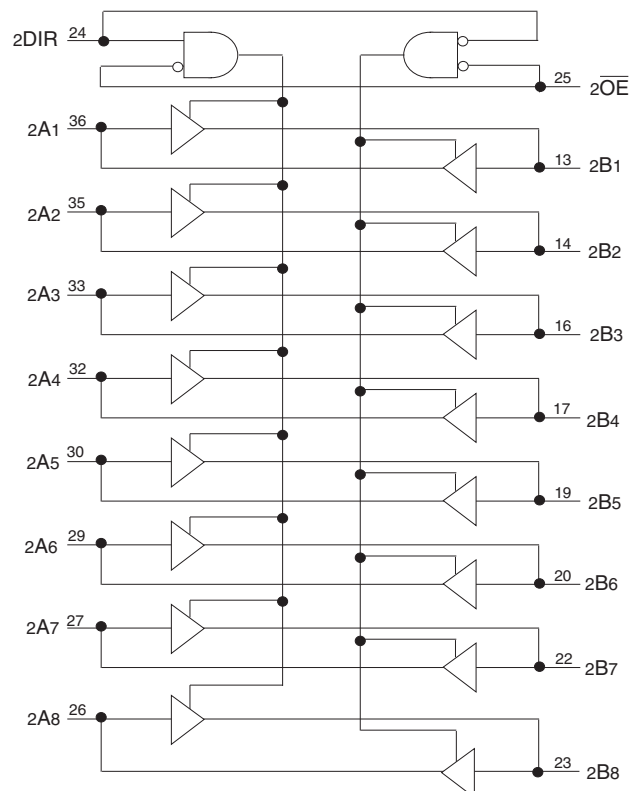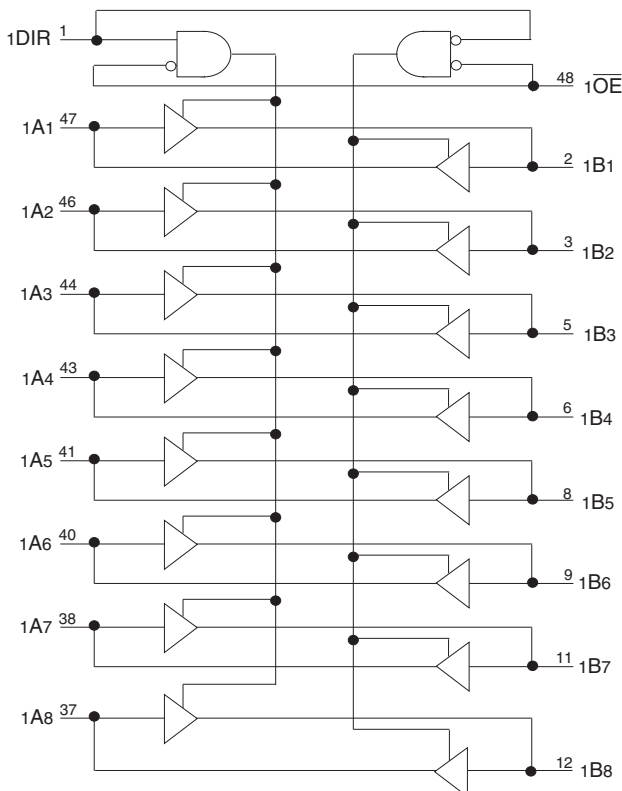
DESCRIPTION:

This 16-bit bus transceiver is built using advanced dual metal CMOS technology. The ALVCHR162245 device is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction control (DIR) input. The output-enable ($\overline{OE}$) input can be used to disable the device so that the buses are effectively isolated.

The ALVCHR162245 has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been designed to drive ±12mA at the designated threshold levels.

The ALVCHR162245 has "bus-hold" which retains the inputs' last state whenever the input bus goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.
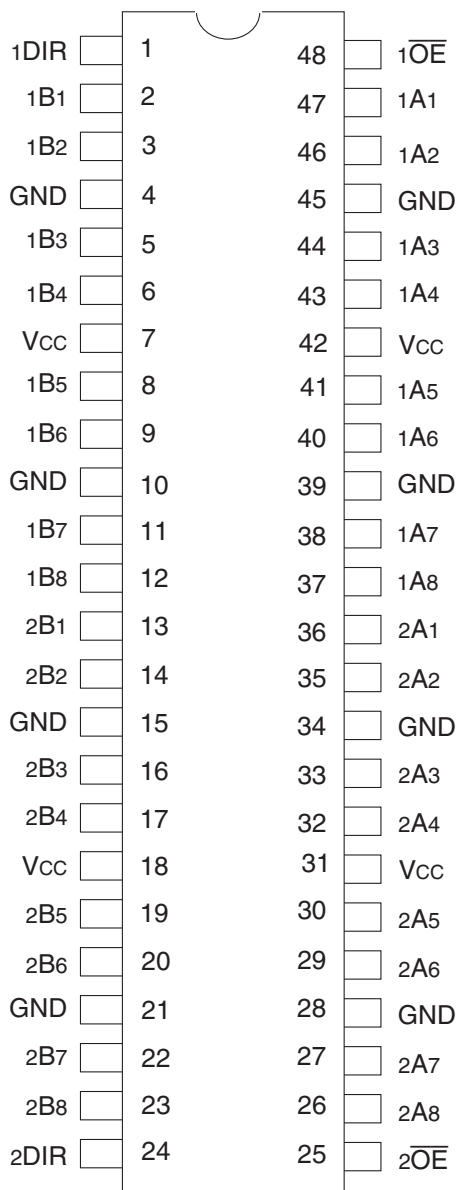
FUNCTIONAL BLOCK DIAGRAM

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INDUSTRIAL TEMPERATURE RANGE

SEPTEMBER 2016

DSC-4606/6

PIN CONFIGURATION

1DIR	1		48	1$\overline{OE}$
1B1	2		47	1A1
1B2	3		46	1A2
GND	4		45	GND
1B3	5		44	1A3
1B4	6		43	1A4
VCC	7		42	VCC
1B5	8		41	1A5
1B6	9		40	1A6
GND	10		39	GND
1B7	11		38	1A7
1B8	12		37	1A8
2B1	13		36	2A1
2B2	14		35	2A2
GND	15		34	GND
2B3	16		33	2A3
2B4	17		32	2A4
VCC	18		31	VCC
2B5	19		30	2A5
2B6	20		29	2A6
GND	21		28	GND
2B7	22		27	2A7
2B8	23		26	2A8
2DIR	24		25	2$\overline{OE}$

TSSOP
TOP VIEW

ABSOLUTE MAXIMUM RATINGS[1]

Symbol	Description	Max	Unit
V_{TERM}[2]	Terminal Voltage with Respect to GND	−0.5 to +4.6	V
V_{TERM}[3]	Terminal Voltage with Respect to GND	−0.5 to V_{CC}+0.5	V
T_{STG}	Storage Temperature	−65 to +150	°C
I_{OUT}	DC Output Current	−50 to +50	mA
I_{IK}	Continuous Clamp Current, V_I < 0 or V_I > V_{CC}	±50	mA
I_{OK}	Continuous Clamp Current, V_O < 0	−50	mA
I_{CC} I_{SS}	Continuous Current through each V_{CC} or GND	±100	mA

NOTES:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V_{CC} terminals.
3. All terminals except V_{CC}.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter[1]	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	5	7	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	7	9	pF
$C_{I/O}$	I/O Port Capacitance	V_{IN} = 0V	7	9	pF

NOTE:
1. As applicable to the device type.

PIN DESCRIPTION

Pin Names	Description
x$\overline{OE}$	Output Enable Inputs (Active LOW)
DIR	Direction Control Inputs
xAx[1]	Side A Inputs or 3-State Outputs
xBx[1]	Side B Inputs or 3-State Outputs

NOTE:
1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE (EACH 8-BIT SECTION)[1]

Inputs		Outputs
x$\overline{OE}$	xDIR	
L	L	Bus B data to A bus
L	H	Bus A data to B bus
H	X	High Z State

NOTE:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Operating Condition: T_A = –40°C to +85°C

Symbol	Parameter	Test Conditions		Min.	Typ.[1]	Max.	Unit
V_{IH}	Input HIGH Voltage Level	V_{CC} = 2.3V to 2.7V		1.7	—	—	V
		V_{CC} = 2.7V to 3.6V		2	—	—	
V_{IL}	Input LOW Voltage Level	V_{CC} = 2.3V to 2.7V		—	—	0.7	V
		V_{CC} = 2.7V to 3.6V		—	—	0.8	
I_{IH}	Input HIGH Current	V_{CC} = 3.6V	$V_I = V_{CC}$	—	—	±5	μA
I_{IL}	Input LOW Current	V_{CC} = 3.6V	V_I = GND	—	—	±5	μA
I_{OZH}	High Impedance Output Current	V_{CC} = 3.6V	$V_O = V_{CC}$	—	—	±10	μA
I_{OZL}	(3-State Output pins)		V_O = GND	—	—	±10	
V_{IK}	Clamp Diode Voltage	V_{CC} = 2.3V, I_{IN} = –18mA		—	–0.7	–1.2	V
V_H	Input Hysteresis	V_{CC} = 3.3V		—	100	—	mV
I_{CCL} I_{CCH} I_{CCZ}	Quiescent Power Supply Current	V_{CC} = 3.6V V_{IN} = GND or V_{CC}		—	0.1	40	μA
ΔI_{CC}	Quiescent Power Supply Current Variation	One input at V_{CC} - 0.6V, other inputs at V_{CC} or GND		—	—	750	μA

NOTE:
1. Typical values are at V_{CC} = 3.3V, +25°C ambient.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter[1]	Test Conditions		Min.	Typ.[2]	Max.	Unit
I_{BHH}	Bus-Hold Input Sustain Current	V_{CC} = 3V	V_I = 2V	– 75	—	—	μA
I_{BHL}			V_I = 0.8V	75	—	—	
I_{BHH}	Bus-Hold Input Sustain Current	V_{CC} = 2.3V	V_I = 1.7V	– 45	—	—	μA
I_{BHL}			V_I = 0.7V	45	—	—	
I_{BHHO}	Bus-Hold Input Overdrive Current	V_{CC} = 3.6V	V_I = 0 to 3.6V	—	—	±500	μA
I_{BHLO}							

NOTES:
1. Pins with Bus-Hold are identified in the pin description.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Max.	Unit
VOH	Output HIGH Voltage	VCC = 2.3V to 3.6V	IOH = – 0.1mA	VCC – 0.2	—	V
		VCC = 2.3V	IOH = – 4mA	1.9	—	
			IOH = – 6mA	1.7	—	
		VCC = 2.7V	IOH = – 4mA	2.2	—	
			IOH = – 8mA	2	—	
		VCC = 3V	IOH = – 6mA	2.4	—	
			IOH = – 12mA	2	—	
VOL	Output LOW Voltage	VCC = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
		VCC = 2.3V	IOL = 4mA	—	0.4	
			IOL = 6mA	—	0.55	
		VCC = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		VCC = 3V	IOL = 6mA	—	0.55	
			IOL = 12mA	—	0.8	

NOTE:
1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate VCC range. TA = – 40°C to + 85°C.

OPERATING CHARACTERISTICS, TA = 25°C

Symbol	Parameter	Test Conditions	VCC = 2.5V ± 0.2V Typical	VCC = 3.3V ± 0.3V Typical	Unit
CPD	Power Dissipation Capacitance Outputs enabled	CL = 0pF, f = 10Mhz	24	32	pF
CPD	Power Dissipation Capacitance Outputs disabled		4	5	

SWITCHING CHARACTERISTICS[1]

Symbol	Parameter	VCC = 2.5V ± 0.2V		VCC = 2.7V		VCC = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
tPLH tPHL	Propagation Delay xAx to xBx or xBx to xAx	1	4.9	—	4.7	1	4.2	ns
tPZH tPZL	Output Enable Time xOE to xAx or xBx	1	6.8	—	6.7	1	5.6	ns
tPHZ tPLZ	Output Disable Time xOE to xAx or xBx	1	6.3	—	5.7	1	5.5	ns
tSK(o)	Output Skew[2]	—	—	—	—	—	500	ps

NOTES:
1. See TEST CIRCUITS AND WAVEFORMS. TA = – 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TEST CIRCUITS AND WAVEFORMS
TEST CONDITIONS

Symbol	Vcc[(1)]=3.3V±0.3V	Vcc[(1)]=2.7V	Vcc[(2)]=2.5V±0.2V	Unit
V_{LOAD}	6	6	2 x Vcc	V
V_{IH}	2.7	2.7	Vcc	V
V_T	1.5	1.5	Vcc / 2	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF

Test Circuit for All Outputs
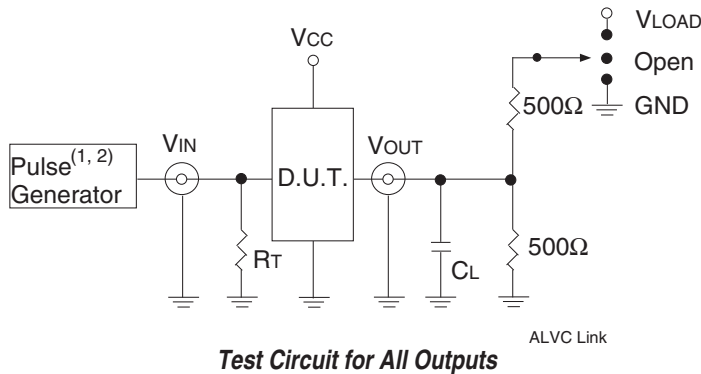
DEFINITIONS:
C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:
1. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.
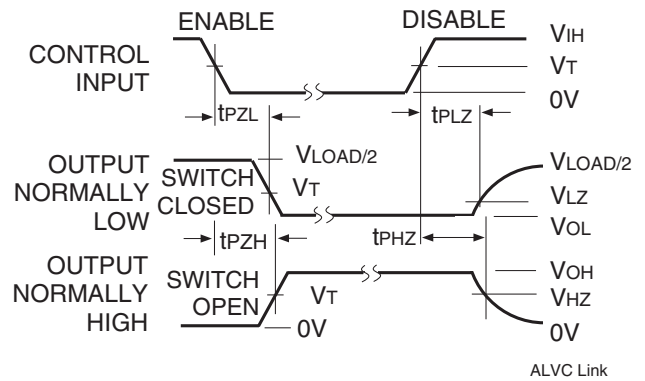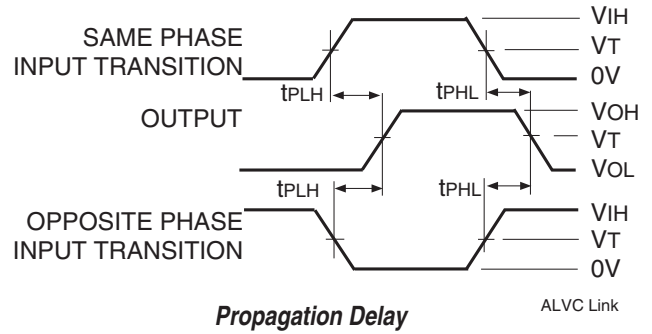2. Pulse Generator for All Pulses: Rate ≤ 1.0MHz; t_F ≤ 2ns; t_R ≤ 2ns.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V_{LOAD}
Disable High Enable High	GND
All Other Tests	Open

$$t_{SK}(x) = | t_{PLH2} - t_{PLH1} | \text{ or } | t_{PHL2} - t_{PHL1} |$$

Output Skew - $t_{SK}(x)$
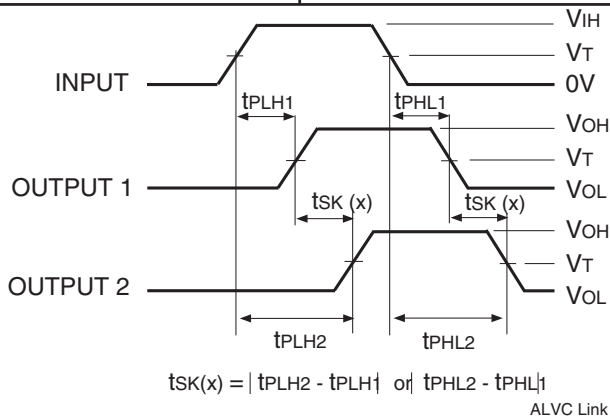
NOTES:
1. For $t_{SK}(o)$ OUTPUT1 and OUTPUT2 are any two outputs.
2. For $t_{SK}(b)$ OUTPUT1 and OUTPUT2 are in the same bank.

Propagation Delay

Enable and Disable Times

NOTE:
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

Set-up, Hold, and Release Times

Pulse Width

ORDERING INFORMATION

XX ALVC X XX XXX XX X
Temp. Range Bus-Hold Family Device Type Package

Blank	Tube
8	Tape and Reel
PAG	Thin Shrink Small Outline Package - Green
245	16-Bit Bus Transceiver with 3-State Outputs
R162	Double-Density with Resistors, ±12mA
H	Bus-Hold
74	-40°C to +85°C
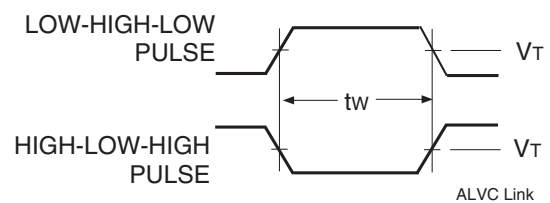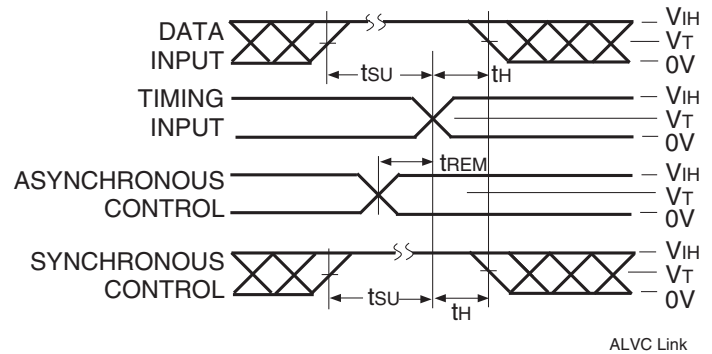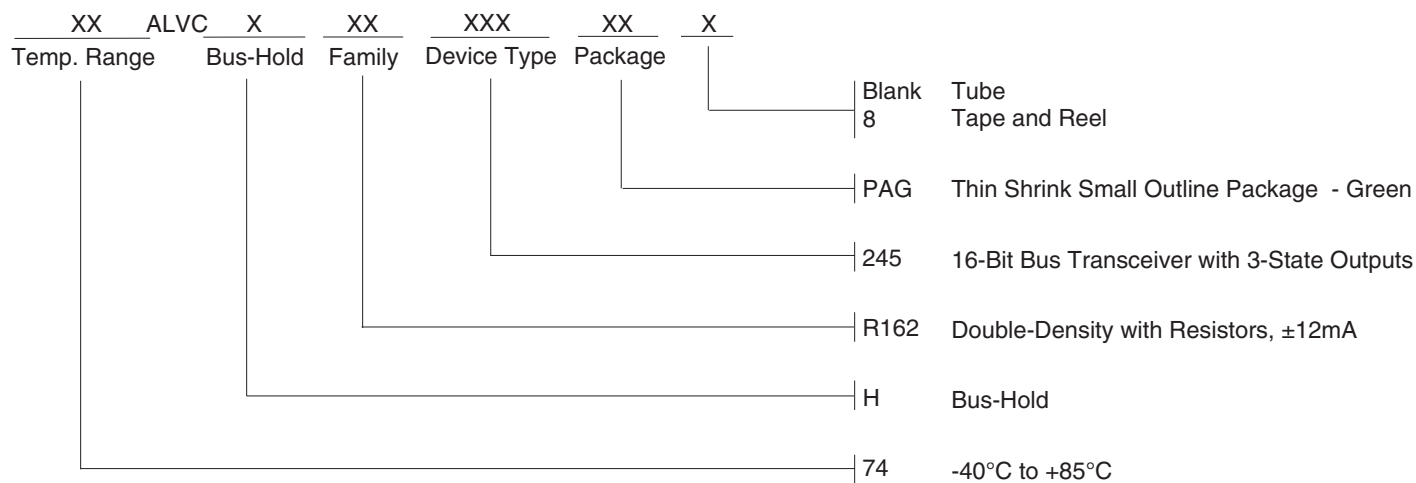
Datasheet Document History

09/19/2016   Pg.   6   Updated the ordering information by adding Tape and Reel.